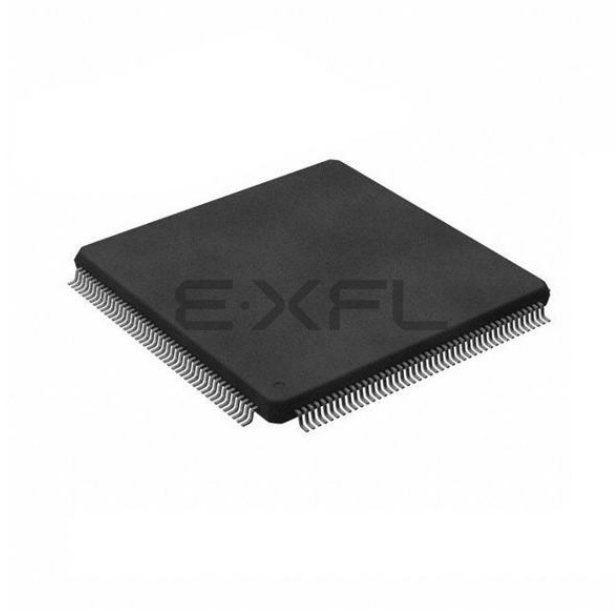


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	FR81S
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	CANbus, CSIO, EBI/EMI, I²C, LINbus, SPI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	152
Program Memory Size	1.0625MB (1.0625M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	136K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 48x12b; D/A 2x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb91f526lubpmc-gsk5e1

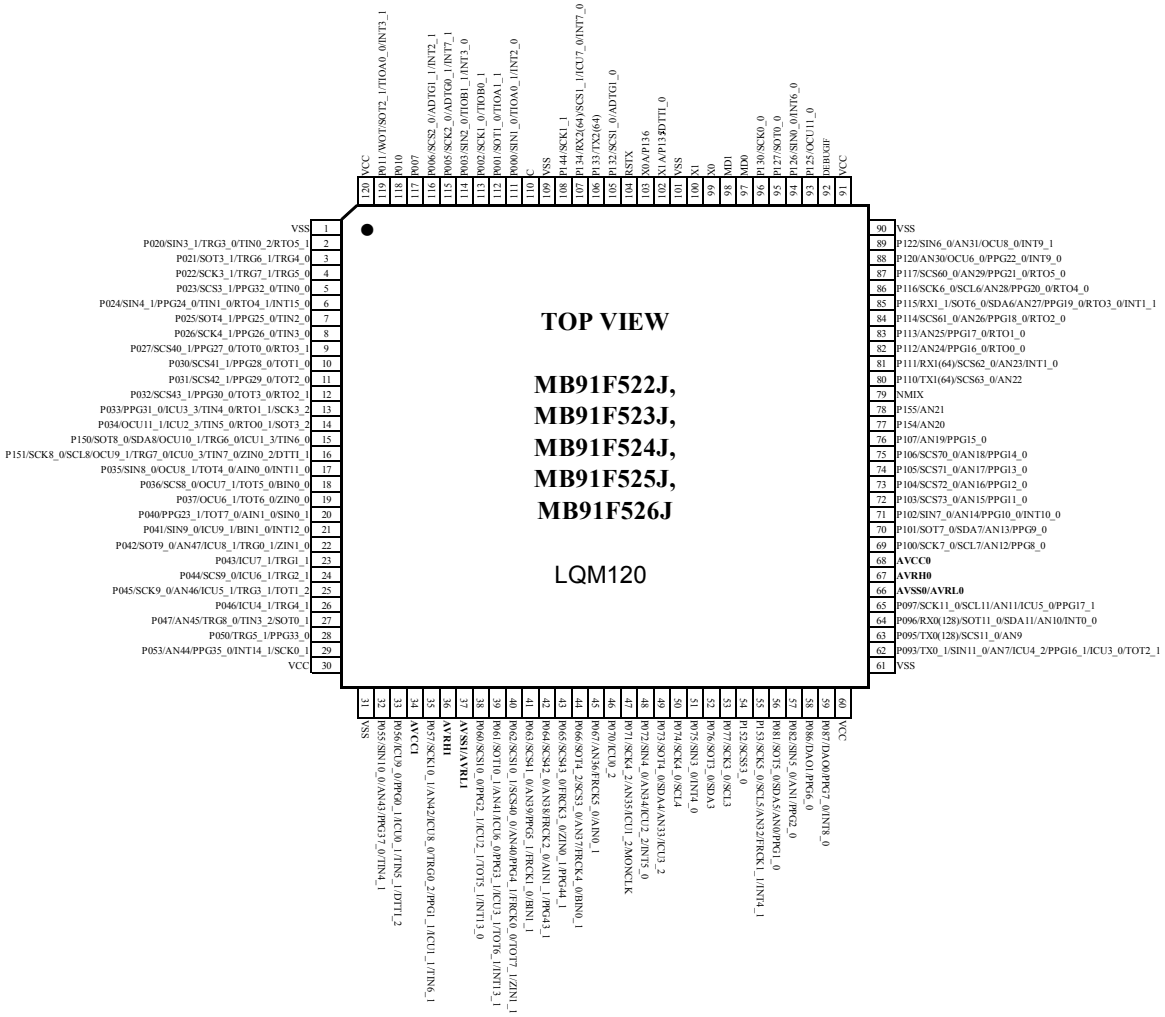
- Power-on reset
- Low-voltage detection reset (independently monitor the external power supply and the internal power supply)
  - The external power supply can select initial value ON/OFF by the part number.
- Device Package : 176/144/120/100/80/64
- CMOS 90nm Technology
- Power supplies
  - 5V Power supply
  - The internal 1.2V is generated from 5V with the voltage step-down circuit

Contents

MB91F52xJ

MB91F522J, MB91F523J, MB91F524J, MB91F525J, MB91F526J

(TOP VIEW)



* In a single clock product, pin 102 and pin 103 are the general-purpose ports.

■ Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

■ Fail-Safe Design

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

■ Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION: Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

2. Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Cypress's recommended conditions. For detailed information about mount conditions, contact your sales representative.

■ Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

■ Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

■ Lead-Free Packaging

CAUTION: When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
$0008A0_H$	WRAR04 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				Wild Register [S]
$0008A4_H$	WRDR04 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008A8_H$	WRAR05 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008AC_H$	WRDR05 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008B0_H$	WRAR06 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008B4_H$	WRDR06 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008B8_H$	WRAR07 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008BC_H$	WRDR07 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008C0_H$	WRAR08 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008C4_H$	WRDR08 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008C8_H$	WRAR09 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008CC_H$	WRDR09 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008D0_H$	WRAR10 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008D4_H$	WRDR10 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008D8_H$	WRAR11 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008DC_H$	WRDR11 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008E0_H$	WRAR12 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008E4_H$	WRDR12 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008E8_H$	WRAR13 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				
$0008EC_H$	WRDR13 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$0008F0_H$	WRAR14 [R/W] W -------- --XXXXXX XXXXXXXX XXXXXX--				

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
$000C4C_H$	DDAR4 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				DMA Controller [S]
$000C50_H$	DCCR5 [R/W] W 0----000 --00--00 00000000 0-000000				
$000C54_H$	DCSR5 [R/W] H 0------- -----000		DTCR5 [R/W] H 00000000 00000000		
$000C58_H$	DSAR5 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C5C_H$	DDAR5 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C60_H$	DCCR6 [R/W] W 0----000 --00--00 00000000 0-000000				
$000C64_H$	DCSR6 [R/W] H 0------- -----000		DTCR6 [R/W] H 00000000 00000000		
$000C68_H$	DSAR6 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C6C_H$	DDAR6 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C70_H$	DCCR7 [R/W] W 0----000 --00--00 00000000 0-000000				
$000C74_H$	DCSR7 [R/W] H 0------- -----000		DTCR7 [R/W] H 00000000 00000000		
$000C78_H$	DSAR7 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C7C_H$	DDAR7 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C80_H$	DCCR8 [R/W] W 0----000 --00--00 00000000 0-000000				
$000C84_H$	DCSR8 [R/W] H 0------- -----000		DTCR8 [R/W] H 00000000 00000000		
$000C88_H$	DSAR8 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C8C_H$	DDAR8 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C90_H$	DCCR9 [R/W] W 0----000 --00--00 00000000 0-000000				
$000C94_H$	DCSR9 [R/W] H 0------- -----000		DTCR9 [R/W] H 00000000 00000000		
$000C98_H$	DSAR9 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
$000C9C_H$	DDAR9 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

Address	Address offset value / Register name				Block
	+0	+1	+2	+3	
001804_H	—	— /(SCSFR24) [R/W] B,H,W -------- *3	— /(SCSFR14) [R/W] B,H,W -------- *3	— /(SCSFR04) [R/W] B,H,W -------- *3	Multi-UART4 *3: Reserved because CSIO mode is not set immediately after reset. *4: Reserved because LIN2.1 mode is not set immediately after reset.
001808_H	—/(TBYTE34)/ (LAMESR4) [R/W] B,H,W -------- *3	—/(TBYTE24)/ (LAMERT4) [R/W] B,H,W -------- *3	—/(TBYTE14)/ (LAMIER4) [R/W] B,H,W -------- *3	TBYTE04/(LAMRID4) / (LAMTID4) [R/W] B,H,W 00000000	
$00180C_H$	BGR4[R/W] H, W 00000000 00000000		— /(ISMK4)[R/W] B,H,W -------- *2	— /(ISBA4)[R/W] B,H,W -------- *2	
001810_H	FCR14[R/W] B,H,W ---00100	FCR04[R/W] B,H,W -0000000	FBYTE4[R/W] B,H,W 00000000 00000000		
001814_H	FTICR4[R/W] B,H,W 00000000 00000000		—	—	
001818_H	SCR5/(IBCR5) [R/W] B,H,W 0--00000	SMR5[R/W] B,H,W 000-00-0	SSR5[R/W] B,H,W 0-000011	ESCR5/(IBSR5)[R/W] B,H,W 00000000	Multi-UART5 *1: Byte access is possible only for access to lower 8 bits. *2: Reserved because I^2C mode is not set immediately after reset. *3: Reserved because CSIO mode is not set immediately after reset. *4: Reserved because LIN2.1 mode is not set immediately after reset.
$00181C_H$	— /(RDR15/(TDR15))[R/W] B,H,W -------- -------- *3		RDR05/(TDR05)[R/W] B,H,W -------0 00000000 *1		
001820_H	SACSR5[R/W] B,H,W 0----000 00000000		STMR5[R] B,H,W 00000000 00000000		
001824_H	STMCR5[R/W] B,H,W 00000000 00000000		— /(SCSCR5/SFUR5)[R/W] B,H,W -------- -------- *3 *4		
001828_H	— /(SCSTR35)/ (LAMSR5) [R/W] B,H,W -------- *3	— /(SCSTR25)/ (LAMCR5) [R/W] B,H,W -------- *3	— /(SCSTR15)/ (SFLR15) [R/W] B,H,W -------- *3	— /(SCSTR05)/ (SFLR05) [R/W] B,H,W -------- *3	
$00182C_H$	—	— /(SCSFR25) [R/W] B,H,W -------- *3	— /(SCSFR15) [R/W] B,H,W -------- *3	— /(SCSFR05) [R/W] B,H,W -------- *3	
001830_H	—/(TBYTE35)/ (LAMESR5) [R/W] B,H,W -------- *3	—/(TBYTE25)/ (LAMERT5) [R/W] B,H,W -------- *3	—/(TBYTE15)/ (LAMIER5) [R/W] B,H,W -------- *3	TBYTE05/(LAMRID5) / (LAMTID5) [R/W] B,H,W 00000000	
001834_H	BGR5[R/W] H, W 00000000 00000000		— /(ISMK5)[R/W] B,H,W -------- *2	— /(ISBA5)[R/W] B,H,W -------- *2	
001838_H	FCR15[R/W] B,H,W ---00100	FCR05[R/W] B,H,W -0000000	FBYTE5[R/W] B,H,W 00000000 00000000		
$00183C_H$	FTICR5[R/W] B,H,W 00000000 00000000		—	—	

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexa decimal				
Multi-function serial interface ch.4 (reception completed)	28	1C	ICR12	$38C_H$	$000FFF8C_H$	12*1
Multi-function serial interface ch.4 (status)						
Multi-function serial interface ch.4 (transmission completed)	29	1D	ICR13	388_H	$000FFF88_H$	13
Multi-function serial interface ch.5 (reception completed)	30	1E	ICR14	384_H	$000FFF84_H$	14*1
Multi-function serial interface ch.5 (status)						
Multi-function serial interface ch.5 (transmission completed)	31	1F	ICR15	380_H	$000FFF80_H$	15
Multi-function serial interface ch.6 (reception completed)	32	20	ICR16	$37C_H$	$000FFF7C_H$	16*1
Multi-function serial interface ch.6 (status)						
Multi-function serial interface ch.6 (transmission completed)	33	21	ICR17	378_H	$000FFF78_H$	17
CAN0	34	22	ICR18	374_H	$000FFF74_H$	-
CAN1	35	23	ICR19	370_H	$000FFF70_H$	-
RAM diagnosis end						
RAM initialization completion						
Error generation during RAM diagnosis						
Backup RAM diagnosis end						
Backup RAM initialization completion						
Error generation during Backup RAM diagnosis						
CAN2	36	24	ICR20	$36C_H$	$000FFF6C_H$	-
Up/down counter 0						
Up/down counter 1						
Real time clock	37	25	ICR21	368_H	$000FFF68_H$	-
-	38	26	ICR22	364_H	$000FFF64_H$	-*6
16-bit Free-run timer 0 (0 detection) / (compare clear)	39	27	ICR23	360_H	$000FFF60_H$	23
PPG 1/10/11/20/30/31	40	28	ICR24	$35C_H$	$000FFF5C_H$	24*3
16-bit Free-run timer 1 (0 detection) / (compare clear)						
PPG 2/3/12/13/23/43	41	29	ICR25	358_H	$000FFF58_H$	25*3
16-bit Free-run timer 2 (0 detection) / (compare clear)						
PPG 4/24/35	42	2A	ICR26	354_H	$000FFF54_H$	26*3
PPG 7/16/17/27/37	43	2B	ICR27	350_H	$000FFF50_H$	27*3
PPG 19	44	2C	ICR28	$34C_H$	$000FFF4C_H$	28*3
16-bit ICU 0 (fetching) / 16-bit ICU 1 (fetching)	45	2D	ICR29	348_H	$000FFF48_H$	29
Main timer	46	2E	ICR30	344_H	$000FFF44_H$	30
Sub timer						
PLL timer						
16-bit ICU 2 (fetching) /16-bit ICU 3 (fetching)						

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexa decimal				
Clock calibration unit (sub oscillation) Multi-function serial interface ch.9 (reception completed) Multi-function serial interface ch.9 (status)	47	2F	ICR31	340_H	$000FFF40_H$	31*1,*4
A/D converter 0/1/7/10/11/14/15/16/17/22/27/28/31	48	30	ICR32	$33C_H$	$000FFF3C_H$	32
Clock calibration unit (CR oscillation) Multi-function serial interface ch.9 (transmission completed) 16-bit OCU 0 (match) / 16-bit OCU 1 (match)	49	31	ICR33	338_H	$000FFF38_H$	33
32-bit Free-run timer 4 16-bit OCU 2 (match) / 16-bit OCU 3 (match)	50	32	ICR34	334_H	$000FFF34_H$	34*5
16-bit OCU 4 (match) / 16-bit OCU 5 (match)	51	33	ICR35	330_H	$000FFF30_H$	35
32-bit ICU6 (fetching/measurement) Multi-function serial interface ch.10 (reception completed) Multi-function serial interface ch.10 (status)	52	34	ICR36	$32C_H$	$000FFF2C_H$	36*1
Multi-function serial interface ch.10 (transmission completed)	53	35	ICR37	328_H	$000FFF28_H$	37
32-bit ICU8 (fetching/measurement) Multi-function serial interface ch.11 (reception completed) Multi-function serial interface ch.11 (status)	54	36	ICR38	324_H	$000FFF24_H$	38*1
32-bit ICU9 (fetching/measurement) WG dead timer underflow 0 / 1/ 2 WG dead timer reload 0 / 1/ 2 WG DTTI 0	55	37	ICR39	320_H	$000FFF20_H$	39
32-bit ICU4 (fetching/measurement) Multi-function serial interface ch.11 (transmission completed)	56	38	ICR40	$31C_H$	$000FFF1C_H$	40
32-bit ICU5 (fetching/measurement) A/D converter 32/34/35/37/38/40/41/42/43/44/45/46/47	57	39	ICR41	318_H	$000FFF18_H$	41
32-bit OCU7/11 (match)	58	3A	ICR42	314_H	$000FFF14_H$	42
32-bit OCU8/9 (match)	59	3B	ICR43	310_H	$000FFF10_H$	43
-	60	3C	ICR44	$30C_H$	$000FFF0C_H$	-*6
- -	61	3D	ICR45	308_H	$000FFF08_H$	-
DMAC0/1/2/3/4/5/6/7/8/9/10/11/12/13/14/15	62	3E	ICR46	304_H	$000FFF04_H$	-
Delay interrupt	63	3F	ICR47	300_H	$000FFF00_H$	-
System reserved (Used for REALOS™*8)	64	40	-	$2FC_H$	$000FFEFC_H$	-
System reserved (Used for REALOS)	65	41	-	$2F8_H$	$000FFEF8_H$	-

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN
	Decimal	Hexadecimal				
32-bit ICU5 (fetching/measurement) A/D converter 32/33/34/35/36/37/38/39/40/41/42/43/44/45/46/47	57	39	ICR41	318_H	$000FFF18_H$	41
32-bit OCU 6/7/10/11 (match)	58	3A	ICR42	314_H	$000FFF14_H$	42
32-bit OCU 8/9 (match)	59	3B	ICR43	310_H	$000FFF10_H$	43
- -	60	3C	ICR44	$30C_H$	$000FFF0C_H$	44
Base timer 1 IRQ0 Base timer 1 IRQ1 - -	61	3D	ICR45	308_H	$000FFF08_H$	45
DMAC 0/1/2/3/4/5/6/7/8/9/10/11/12/13/14/15	62	3E	ICR46	304_H	$000FFF04_H$	-
Delay interrupt	63	3F	ICR47	300_H	$000FFF00_H$	-
System reserved (Used for REALOS)	64	40	-	$2FC_H$	$000FFEFC_H$	-
System reserved (Used for REALOS)	65	41	-	$2F8_H$	$000FFEF8_H$	-
Used with the INT instruction	66 | 255	42 | FF	-	$2F4_H$ | 000_H	$000FFEF4_H$ | $000FFC00_H$	-

Note: It does not support a DMA transfer request caused by an interrupt generated from a peripheral to which no RN (Resource Number) is assigned.

*1: It does not support a DMA transfer by the status of the multi-function serial interface and I^2C reception.

*2: Reload timer ch.4 to ch.7 do not support a DMA transfer by the interrupt.

*3: PPG ch.24 to ch.47 do not support a DMA transfer by the interrupt.

*4: The clock calibration unit does not support a DMA transfer by the interrupt.

*5: 32-bit Free-run timer ch.3, ch.4 and ch.5 do not support a DMA transfer by the interrupt.

*6: There is no resource corresponding to the interrupt level.

*7: It does not support a DMA transfer by the external low-voltage detection interrupt.

DC Characteristics

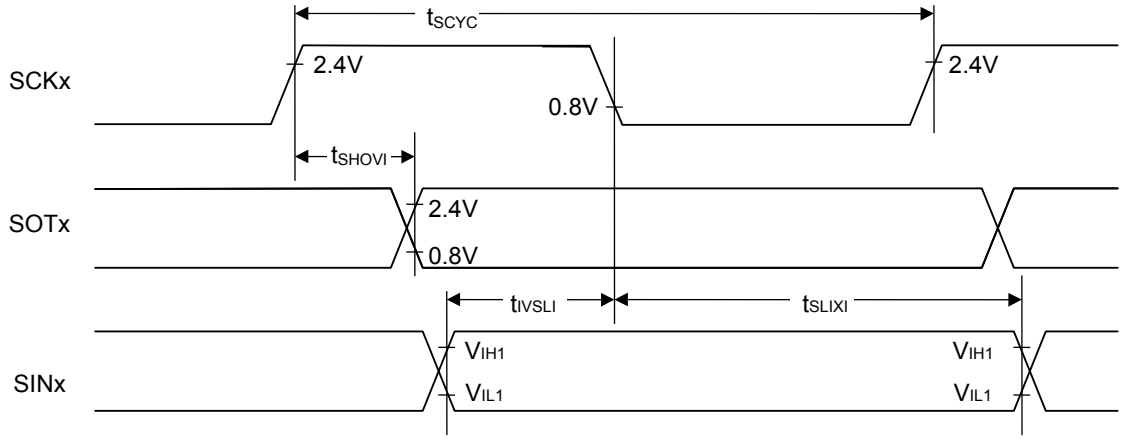
(T_A: -40°C to +105°C, V_{CC}= AVcc=5.0V±10%/3.3V±0.3V, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions		Value Min	Value Typ	Value Max	Unit	Remarks
Power supply current	$I_{CC}5$	VCC	Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at normal operation		-	60	80	mA	
			Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at Flash write		-	70	90	mA	
			Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at Flash erase		-	70	90	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at normal operation		-	54	71	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at Flash write		-	64	81	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at Flash erase		-	64	81	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at normal operation		-	46	62	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at Flash write		-	56	72	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at Flash erase		-	56	72	mA	
	$I_{CCS}5$		Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at CPU sleep mode		-	45	61	mA	
	$I_{CCBS}5$		Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at bus sleep mode		-	23	51	mA	
	$I_{CCT}5$		Watch mode	When using crystal 4MHz T_A=+25°C*	-	1500	2610	µA	
				When using built-in CR clock 50kHz T_A=+25°C*	-	450	2000		
				When using sub clock 32kHz T_A=+25°C*	-	460	2000		
	$I_{CCH}5$		Stop mode	T_A=+25°C*	-	450	2000	µA	
	$I_{CCT}52$		Watch mode (power off)	When using crystal 4MHz T_A=+25°C*	-	1100	1300	µA	LVD/ RTC operation, Backup RAM 8KB retention
				When using built-in CR clock 50kHz , T_A=+25°C*	-	77	267		
				When using sub clock 32kHz T_A=+25°C*	-	100	285		
	$I_{CCH}52$		Stop mode (power off)	T_A=+25°C*	-	74	265	µA	Backup RAM 8KB retention

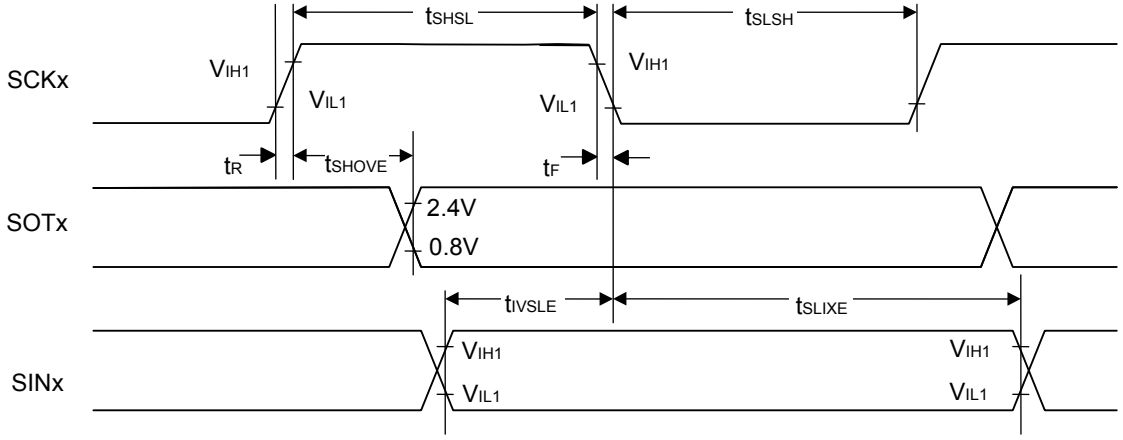
(T_A: -40°C to +125°C, V_{CC}= AVcc=5.0V±10%/3.3V±0.3V, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions		Value Min	Value Typ	Value Max	Unit	Remarks
Power supply current	$I_{CC}5$	VCC	Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at normal operation		-	60	102	mA	
			Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at Flash write		-	70	115	mA	
			Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at Flash erase		-	70	115	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at normal operation		-	54	92	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at Flash write		-	64	105	mA	
			Operating frequency F_{CP}=64MHz, Fcpp=32MHz, at Flash erase		-	64	105	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at normal operation		-	46	82	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at Flash write		-	56	95	mA	
			Operating frequency F_{CP}=48MHz, Fcpp=24MHz, at Flash erase		-	56	95	mA	
	$I_{CCS}5$		Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at CPU sleep mode		-	45	82	mA	
	$I_{CCBS}5$		Operating frequency F_{CP}=80MHz, Fcpp=40MHz, at bus sleep mode		-	23	72	mA	
	$I_{CCT}5$		Watch mode	When using crystal 4MHz T_A=+25°C*	-	1500	2610	µA	
				When using built-in CR clock 50kHz T_A=+25°C*	-	450	2000		
				When using sub clock 32kHz T_A=+25°C*	-	460	2000		
	$I_{CCH}5$		Stop mode	T_A=+25°C*	-	450	2000	µA	
	$I_{CCT}52$		Watch mode (power off)	When using crystal 4MHz T_A=+25°C*	-	1100	1300	µA	LVD/ RTC operation , Backup RAM 8KB retention
				When using built-in CR clock 50kHz , T_A=+25°C*	-	77	267		
				When using sub clock 32kHz T_A=+25°C*	-	100	285		
	$I_{CCH}52$		Stop mode (power off)	T_A=+25°C*	-	74	265	µA	Backup RAM 8KB retention

☐Internal shift clock mode



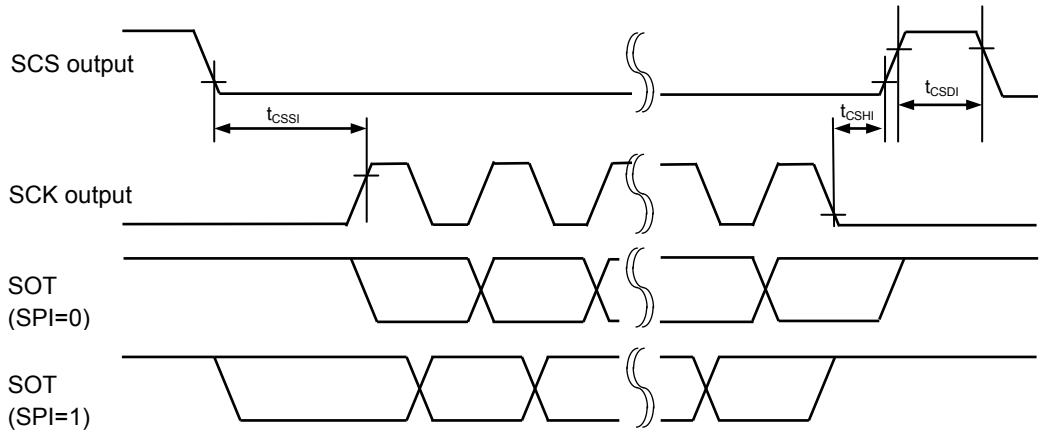
・External shift clock mode



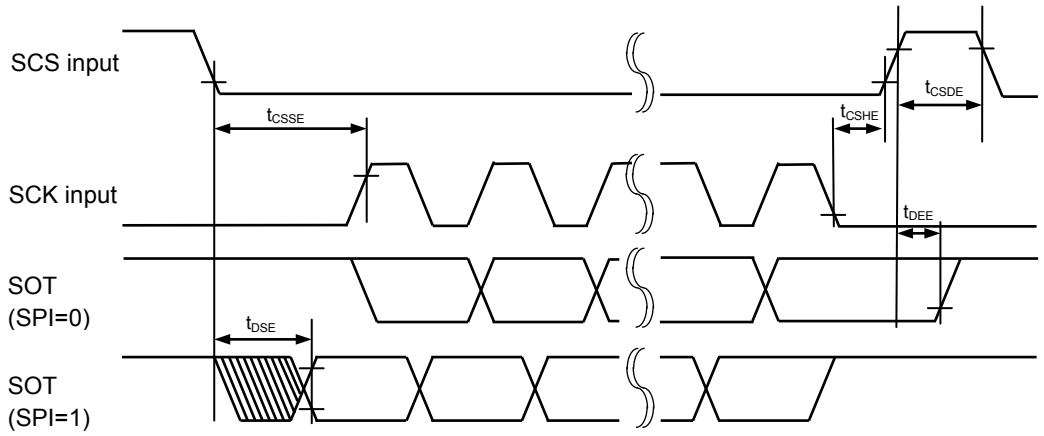
Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
SCS↓→SCK↑ setup time	t_{CSSE}	SCK1 to SCK11 SCS1 to SCS3, SCS40 to SCS43, SCS50 to SCS53, SCS60 to SCS63, SCS70 to SCS73, SCS8 to SCS11	-	$3t_{CPP}$+30	-	ns	External shift clock mode output pin: C_L=50pF
SCK↓→SCS↑ hold time	t_{CSHE}			+0	-	ns	
SCS deselect time	t_{CSDE}	SCS1 to SCS3, SCS40 to SCS43, SCS50 to SCS53, SCS60 to SCS63, SCS70 to SCS73, SCS8 to SCS11		$3t_{CPP}$+30	-	ns	
SCS↓→SOT delay time	t_{DSE}	SCS1 , SCS2, SCS50 to SCS53, SCS60 to SCS63, SCS70 to SCS73, SCS8 to SCS11 SOT1 , SOT2, SOT5 to SOT11		-	40	ns	
		SCS3, SCS40 to SCS43 SOT3 , SOT4		-	300	ns	
SCS↑→SOT delay time	t_{DEE}	SCS1 to SCS3, SCS40 to SCS43, SCS50 to SCS53, SCS60 to SCS63, SCS70 to SCS73, SCS8 to SCS11 SOT1 to SOT11	-	+0	-	ns	External shift clock mode output pin: C_L=50pF
SCK↑→SCS↓ clock switch time	t_{SCC}	SCK1 , SCK2, SCK5 to SCK11 SCS1 , SCS2, SCS50 to SCS53, SCS60 to SCS63, SCS70 to SCS73, SCS8 to SCS11	-	$3t_{CPP}$-10	$3t_{CPP}$+50	ns	Internal shift clock mode Round operation output pin: C_L=50pF
		SCK3 , SCK4 SCS3 , SCS40 to SCS43		$3t_{CPP}$-300	$3t_{CPP}$+50	ns	

*1: t_{CSSU} =SCSTR:CSSU7-0×Serial chip select timing operating clock
*2: t_{CSHD}=SCSTR:CSHD7-0×Serial chip select timing operating clock
*3: t_{CSDS}=SCSTR:CSDS15-0×Serial chip select timing operating clock
Regardless of the deselect time setting, once after the serial chip select pin becomes inactive, it will take at least five peripheral bus clock cycles to be active again

Please see the hardware manual for details of above-mentioned *1,*2, and *3



When Serial chip select is used , Serial clock output mark level "L",
Serial chip select Inactive level "H"
Internal shift clock mode

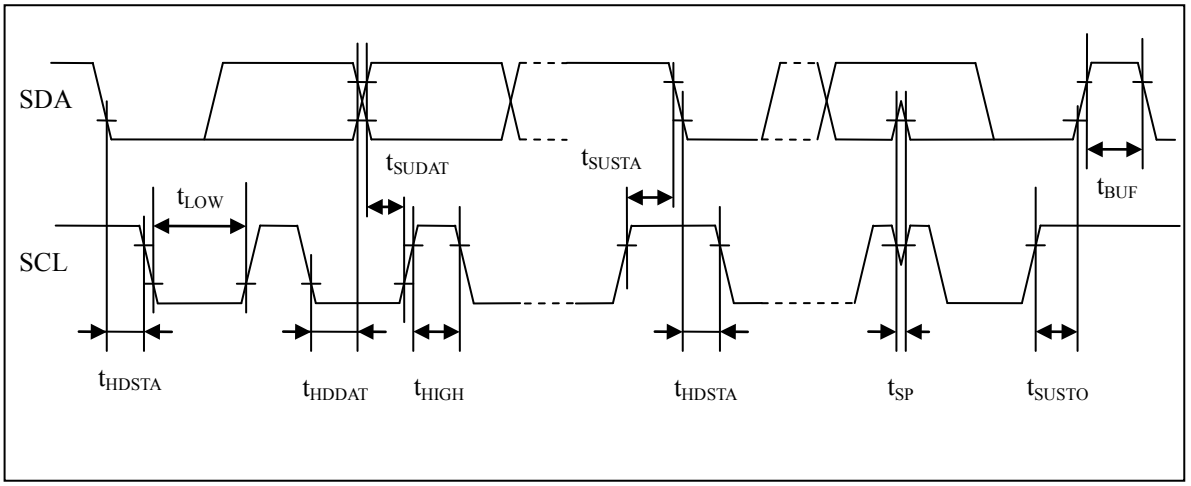


When Serial chip select is used , Serial clock output mark level "L",
Serial chip select Inactive level "H"
External shift clock mode

"t_{SUDAT} ≥ 250 ns".

*4: t_{CPP} is the peripheral clock cycle time. Adjust the clock of the bus in the surrounding to 8MHz or more when use I^2C.

・ I^2C timing

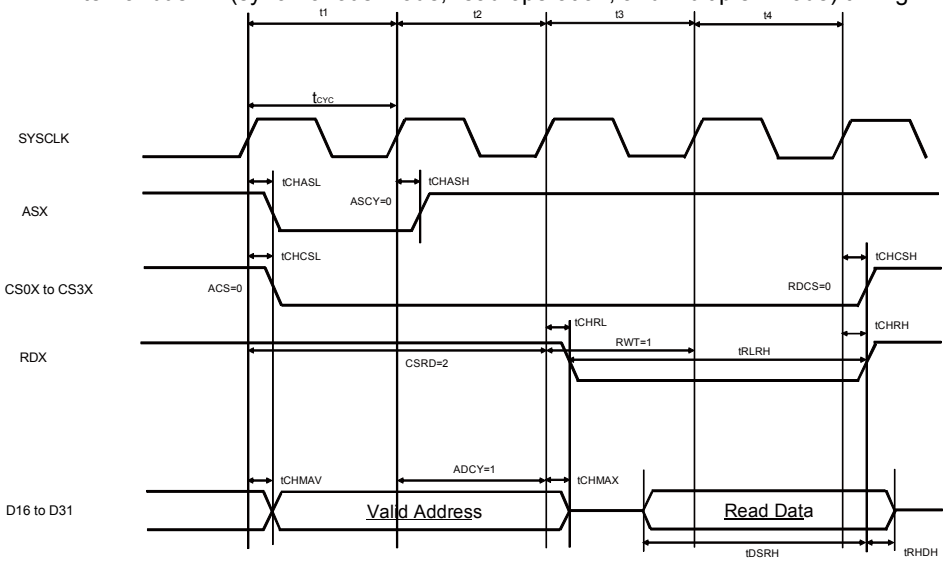


Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
WRnX delay time	t_{CHWL}, t_{CHWH}	SYSCLK WR0X, WR1X	0.5	18	ns	
WRnX minimum pulse	t_{WLWH}	WR0X, WR1X	t_{CYC} - 10	-	ns	WWT=0 *2
SYSCLK↑→ data output time	t_{CHDV}	SYSCLK D16 to D31	0.5	18	ns	
SYSCLK↑→ data hold time	t_{CHDX}		-	18	ns	Set WRCS to 1 or more.
SYSCLK↑→ address output time	t_{CHMAV}	SYSCLK D16 to D31	0.5	18	ns	
SYSCLK↑→ address hold time	t_{CHMAX}		-	18	ns	In multiplex mode, set as follows: □Set CSWR and CSRD to 2 or more. □ASCY must satisfy the following conditions because of setting ADCY > ASCY and protocol violation prevention. ADCY +1 ≤ ACS + CSRD ADCY +1 ≤ ACS + CSWR ASCY + 1 ≤ ACS + CSRD ASCY + 1 ≤ ACS + CSWR See Hardware Manual for details.

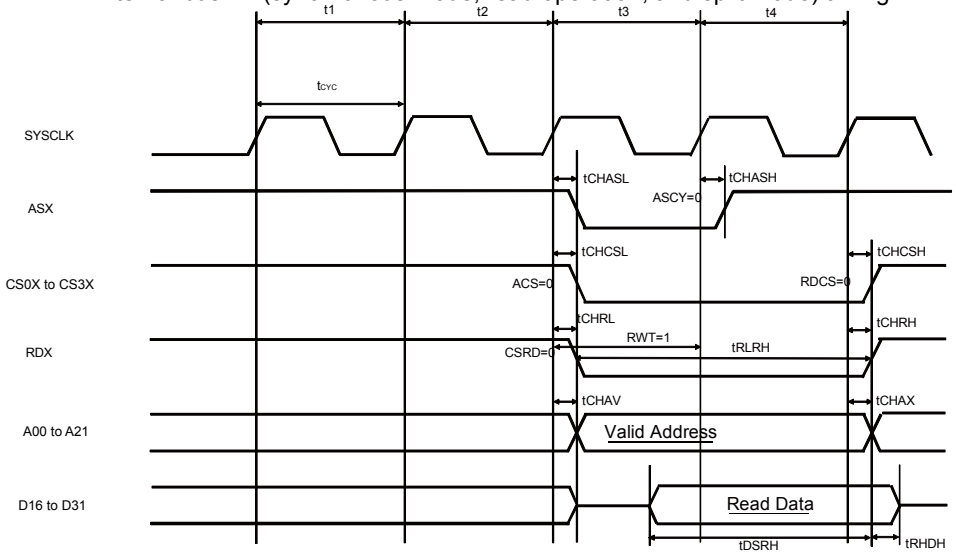
*1: Please use it with external load capacity 12pF or less for VCC=3.3V±0.3V (40MHz operation).

*2: If the bus is expanded by automatic wait insertion or RDY input, add time (t_{CYC} × the number of expanded cycles) to the rated value.

External bus I/F (synchronous mode, read operation, and multiplex mode) timing



External bus I/F (synchronous mode, read operation, and split mode) timing



Part number	Sub clock	CSV Initial value	LVD Initial value	Package*2
MB91F526DWBPMC	Yes	ON	ON	LQH・80 pin, Plastic
MB91F526DYBPMC			OFF	
MB91F526DJBPMC		OFF	ON	
MB91F526DLBPMC			OFF	
MB91F525DWBPMC		ON	ON	
MB91F525DYBPMC			OFF	
MB91F525DJBPMC		OFF	ON	
MB91F525DLBPMC			OFF	
MB91F524DWBPMC		ON	ON	
MB91F524DYBPMC			OFF	
MB91F524DJBPMC		OFF	ON	
MB91F524DLBPMC			OFF	
MB91F523DWBPMC		ON	ON	
MB91F523DYBPMC			OFF	
MB91F523DJBPMC		OFF	ON	
MB91F523DLBPMC			OFF	
MB91F522DWBPMC		ON	ON	
MB91F522DYBPMC			OFF	
MB91F522DJBPMC		OFF	ON	
MB91F522DLBPMC			OFF	
MB91F526DSBPMC	None	ON	ON	
MB91F526DUBPMC			OFF	
MB91F526DHBPMC		OFF	ON	
MB91F526DKBPMC			OFF	
MB91F525DSBPMC		ON	ON	
MB91F525DUBPMC			OFF	
MB91F525DHBPMC		OFF	ON	
MB91F525DKBPMC			OFF	
MB91F524DSBPMC		ON	ON	
MB91F524DUBPMC			OFF	
MB91F524DHBPMC		OFF	ON	
MB91F524DKBPMC			OFF	
MB91F523DSBPMC		ON	ON	
MB91F523DUBPMC			OFF	
MB91F523DHBPMC		OFF	ON	
MB91F523DKBPMC			OFF	
MB91F522DSBPMC		ON	ON	
MB91F522DUBPMC			OFF	
MB91F522DHBPMC		OFF	ON	
MB91F522DKBPMC			OFF	

<table>
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<tr><td>TIN5_0</td></tr>
<tr><td>RTO0_1</td></tr>
<tr><td>SOT3_2</td></tr>
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<tr><td rowspan="8">8 *1</td><td rowspan="8">10 *1</td><td rowspan="8">13</td><td rowspan="8">16</td><td rowspan="8">19</td><td rowspan="8">23</td><td>P151</td></tr>
<tr><td>SCK8_0/ SCL8 *2, *3</td></tr>
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<tr><td>TRG7_0</td></tr>
<tr><td>ICU0_3</td></tr>
<tr><td>TIN7_0</td></tr>
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<tr><td>DTTI_1</td></tr>
<tr><td rowspan="8">9 *1</td><td rowspan="8">11 *1</td><td rowspan="8">14 *1</td><td rowspan="8">17 *1</td><td rowspan="8">20</td><td rowspan="8">24</td><td>P035</td></tr>
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<tr><td>BIN0_0</td></tr>
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<tr><td rowspan="5">-</td><td rowspan="5">-</td><td rowspan="5">16 *1</td><td rowspan="5">19 *1</td><td rowspan="5">22</td><td rowspan="5">26</td><td>P037</td></tr>
<tr><td>A09 *4, *5</td></tr>
<tr><td>OCU6_1</td></tr>
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<tr><td>ZIN0_0</td></tr>
<tr><td rowspan="2">-</td><td rowspan="2">-</td><td rowspan="2">-</td><td rowspan="2">-</td><td rowspan="2">-</td><td rowspan="2">27</td><td>P174</td></tr>
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